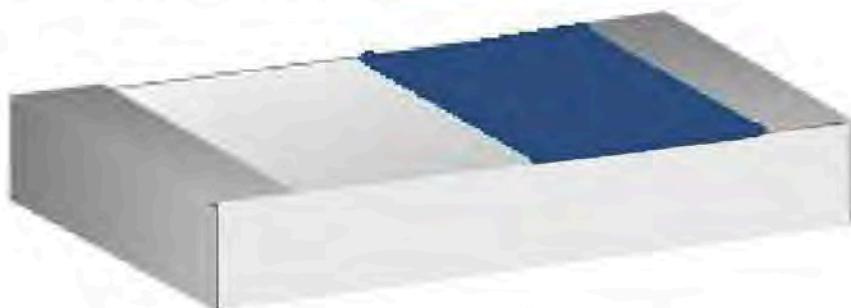


--3.2X1.6X0.5 (mm) WiFi/Bluetooth Ceramic Chip Antenna (FH100A)  
Engineering Specification

1. Product Number

**FH 3216 S1 P 2G45 01**  
1 2 3 4 5 6



|                  |              |
|------------------|--------------|
| (1) Product Type | Chip Antenna |
| (2) Size Code    | 3.2x1.6mm    |
| (3) Type Code    | S1           |
| (4) Packing      | Paper Tape   |
| (5) Frequency    | 2.45GHz      |



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Designed by :Lewis

Checked by : Lewis

Approved by : MR.MENG

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Antenna (FH100A) Engineering Specification

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NO.

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## 2. Features

- \*Stable and reliable in performances
- \*Low temperature coefficient of frequency
- \*Low profile, compact size
- \*RoHS compliance
- \*SMT processes compatible

## 3. Applications

- \*Bluetooth earphone systems
- \*Hand-held devices when WiFi /Bluetooth functions are needed, e.g., Smart phone.
- \*IEEE802.11 b/g/n
- \*ZigBee
- \*Wireless PCMCIA cards or USB dongle

## 4. Description

Yingfeng chip antenna series are specially designed for WiFi/Bluetooth applications. Based on yingfeng proprietary design and processes, this chip antenna has excellent stability and sensitivity to consistently provide high signal reception efficiency.

## 5. Electrical Specifications (80 x 40 mm<sup>2</sup> ground plane)

5-1. Electrical Table

| Characteristics    | Specifications      | Unit |
|--------------------|---------------------|------|
| Outline Dimensions | 3.2x1.6x0.5         | mm   |
| Working Frequency  | 2400~2500           | MHz  |
| VSWR               | 2 Max.              |      |
| Impedance          | 50                  | Ω    |
| Polarization       | Linear Polarization |      |



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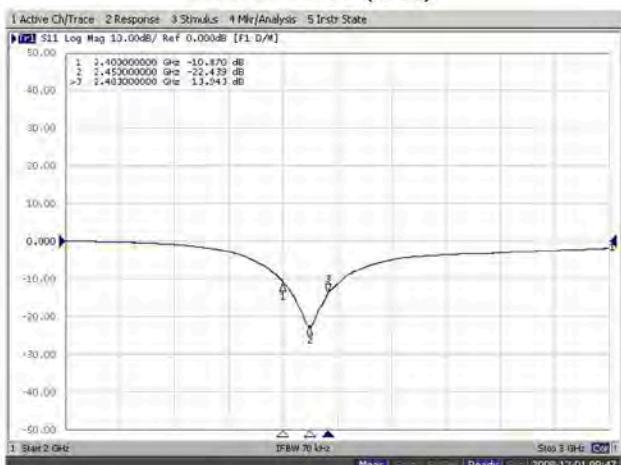
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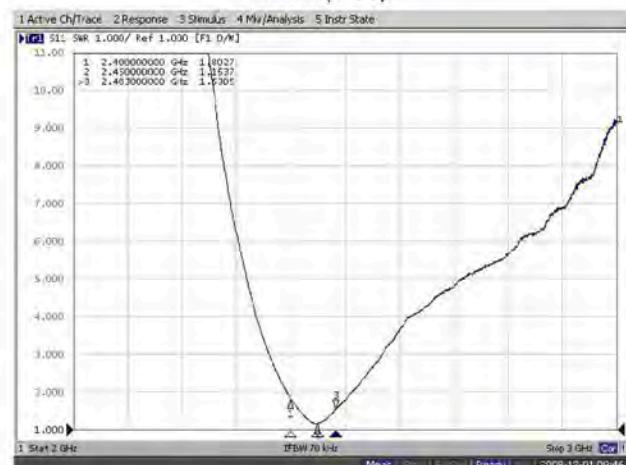
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## 5-2. Return Loss & VSWR

Return Loss (S11)



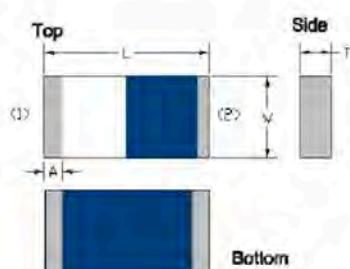
VSWR(S11)



## 6. Antenna Dimensions & Test Board (unit: mm)

### a. Antenna Dimensions

#### Dimension and Terminal Configuration



| Dimension (mm) |            |
|----------------|------------|
| L              | 3.15+-0.15 |
| W              | 1.55+-0.15 |
| T              | 0.50+-0.10 |
| A              | 0.35+-0.10 |

| No. | Terminal Name |
|-----|---------------|
| 1   | Feeding point |
| 2   | GND           |



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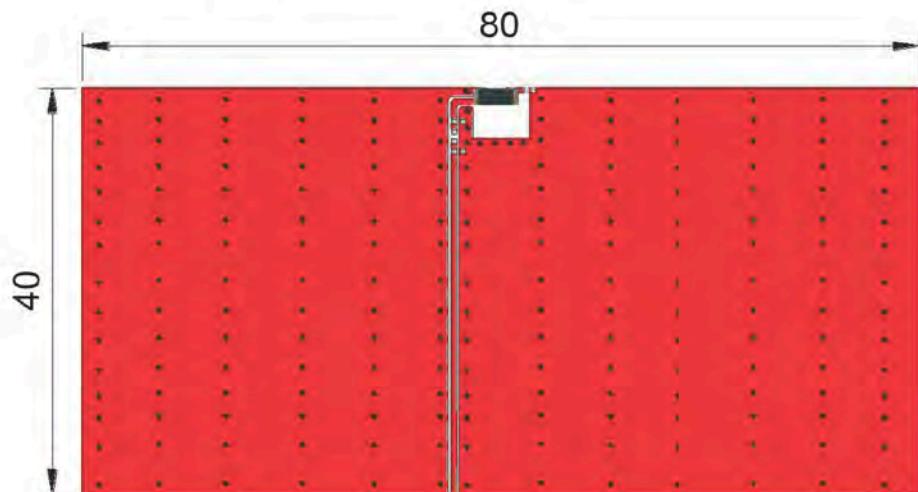
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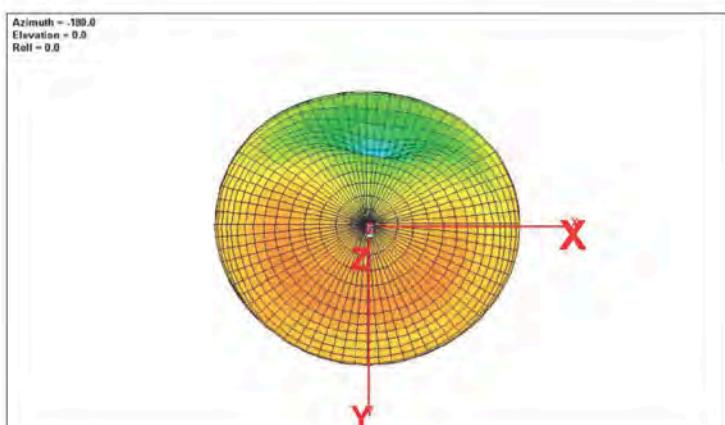
b. Test Board with Antenna



Unit: mm

## 7. Radiation Pattern (80 x 40 mm<sup>2</sup> ground plane)

### 7-1. 3D Gain Pattern @ 2442 MHz



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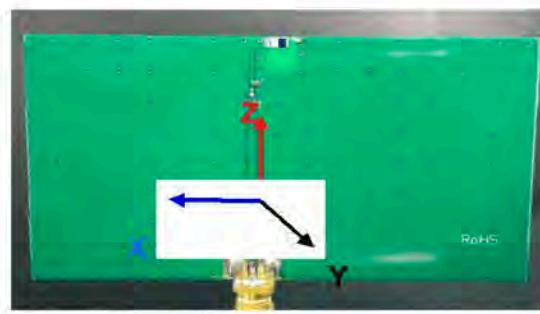
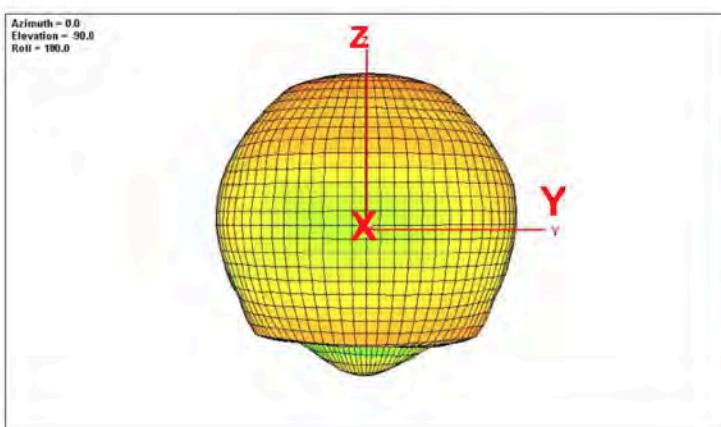
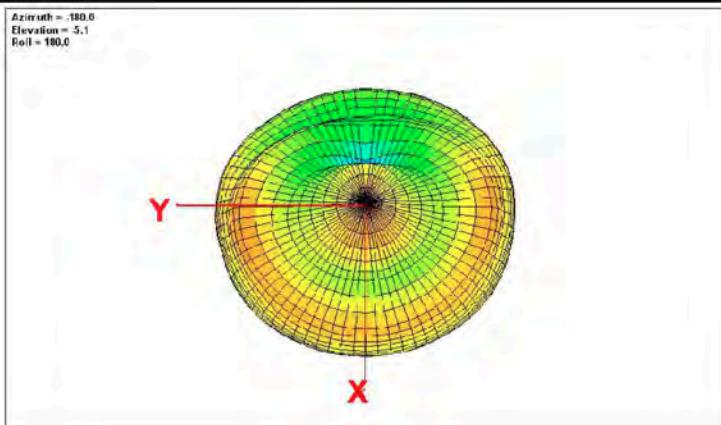
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7-2. 3D Efficiency Table

| Frequency( MHz) | 2400 | 2410 | 2420 | 2430 | 2442 | 2450 | 2460 | 2470 | 2480 | 2490 | 2500 |
|-----------------|------|------|------|------|------|------|------|------|------|------|------|
| Efficiency (dB) | -1.4 | -1.0 | -0.9 | -0.7 | -0.7 | -0.8 | -0.9 | -1.1 | -1.2 | -1.3 | -1.4 |
| Efficiency (%)  | 72.8 | 73.7 | 74.3 | 74.4 | 75.5 | 75.0 | 74.0 | 73.6 | 73.1 | 72.6 | 71.5 |
| Gain (dBi)      | 2.1  | 2.2  | 2.3  | 2.4  | 2.5  | 2.5  | 2.4  | 1.8  | 1.7  | 1.6  | 1.4  |



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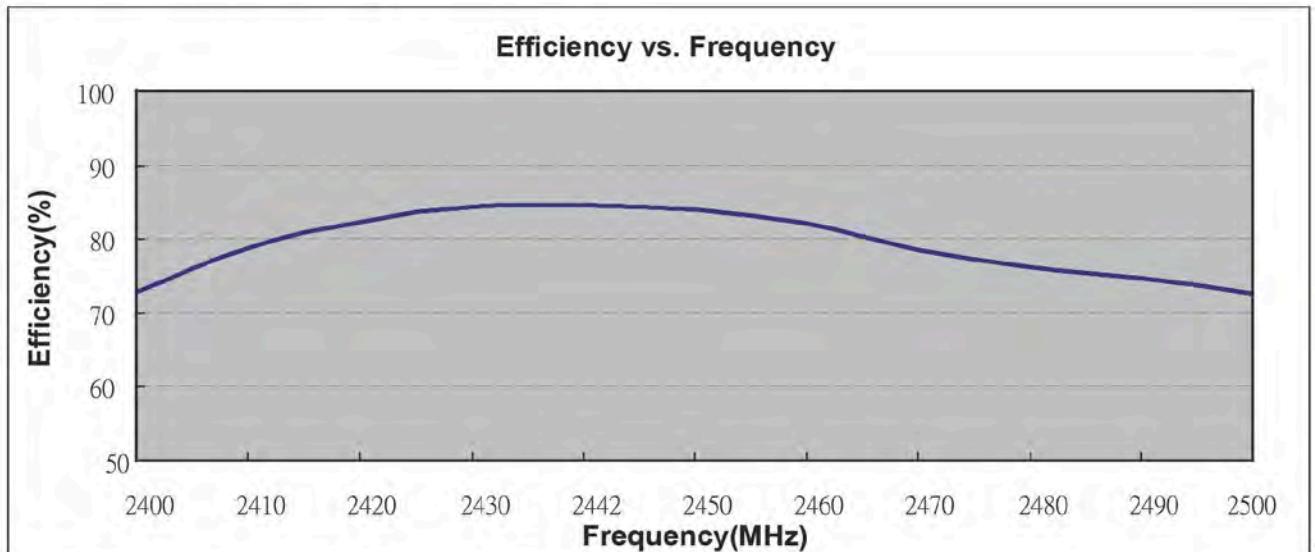
Designed by :Lewis

Checked by : Lewis

Approved by : MR.MENG

|   |  |              |                 |        |
|---|--|--------------|-----------------|--------|
| TITLE : 3.2 x 1.6 x 0.5(mm) WiFi/Bluetooth Ceramic Chip<br>Antenna (FH100A) Engineering Specification |  | DOCUMENT NO. | FH3216S1P2G4501 | REV. B |
|---|--|--------------|-----------------|--------|

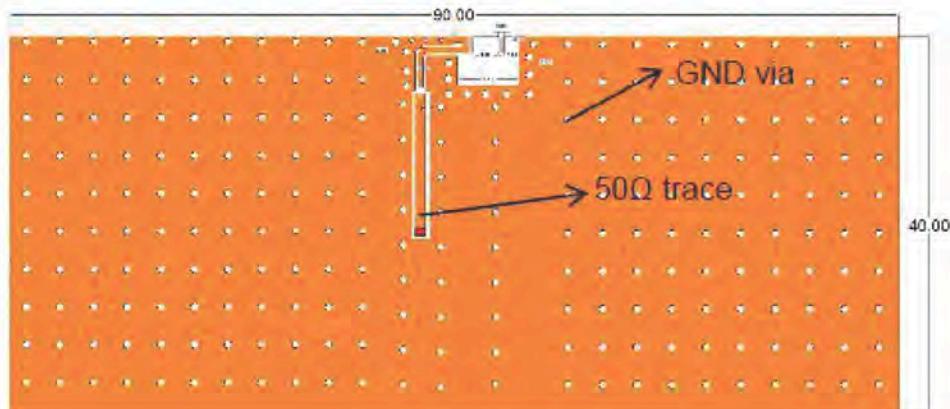
### 7-3. 3D Efficiency vs. Frequency



## 8. Layout Guide

### a. Solder Land Pattern:

Land pattern for soldering (gray marking areas) is as shown below. Depending on Customer's requirement, matching circuit as shown below is also recommended.



Top view



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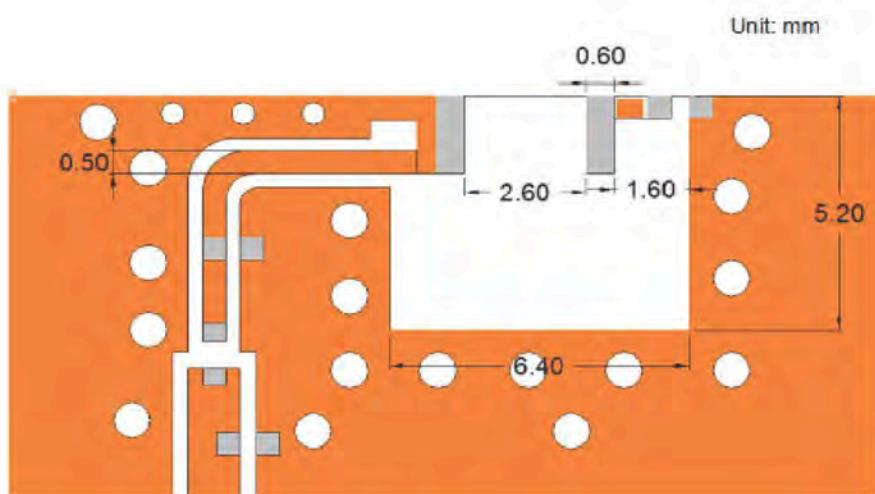
Approved by : MR.MENG

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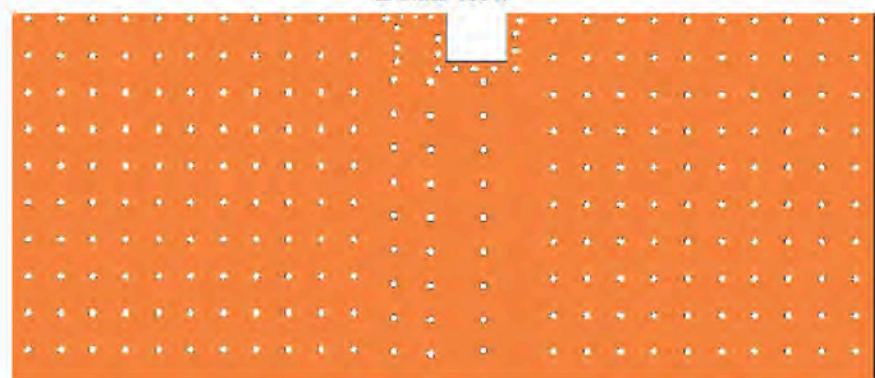
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Detail view



Bottom view



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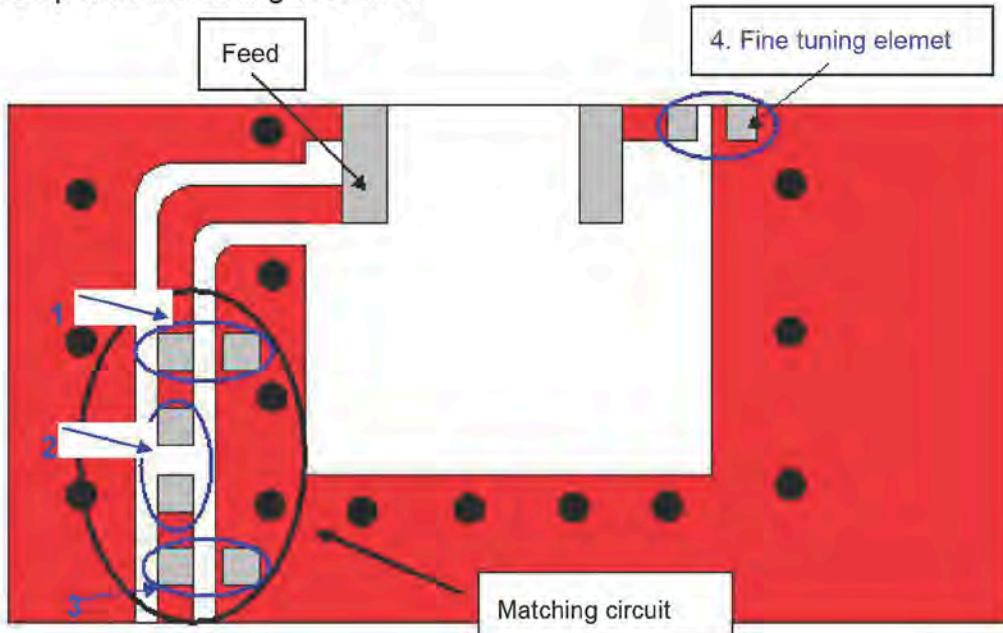
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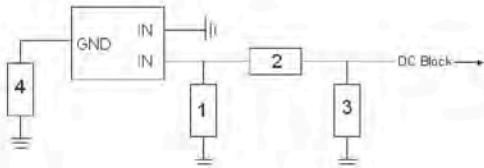
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## 9. Frequency tuning

a. Chip antenna tuning scenario:



b. Matching circuit : (Center frequency is about 2442 MHz @ 80 x 40 mm<sup>2</sup> ground plane)



| System Matching Circuit Component |             |               |           |
|-----------------------------------|-------------|---------------|-----------|
| Location                          | Description | Vendor        | Tolerance |
| 1                                 | 1.2 pF*     | Murata (0402) | ±0.1 pF   |
| 2                                 | 10PF*       | Murata(0402)  | ±0.5 PF   |
| 3                                 | N/A*        | -             | -         |
| Fine tuning element 4             | 1.5 pF*     | Murata (0402) | ±0.1 pF   |

\*Typical reference values which may need to be changed when circuit boards or part vendors are different.



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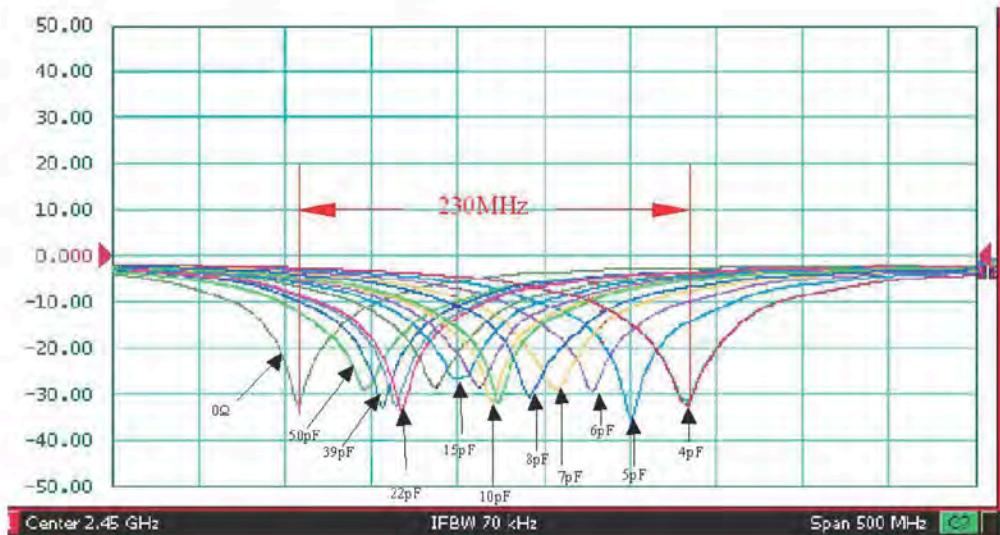
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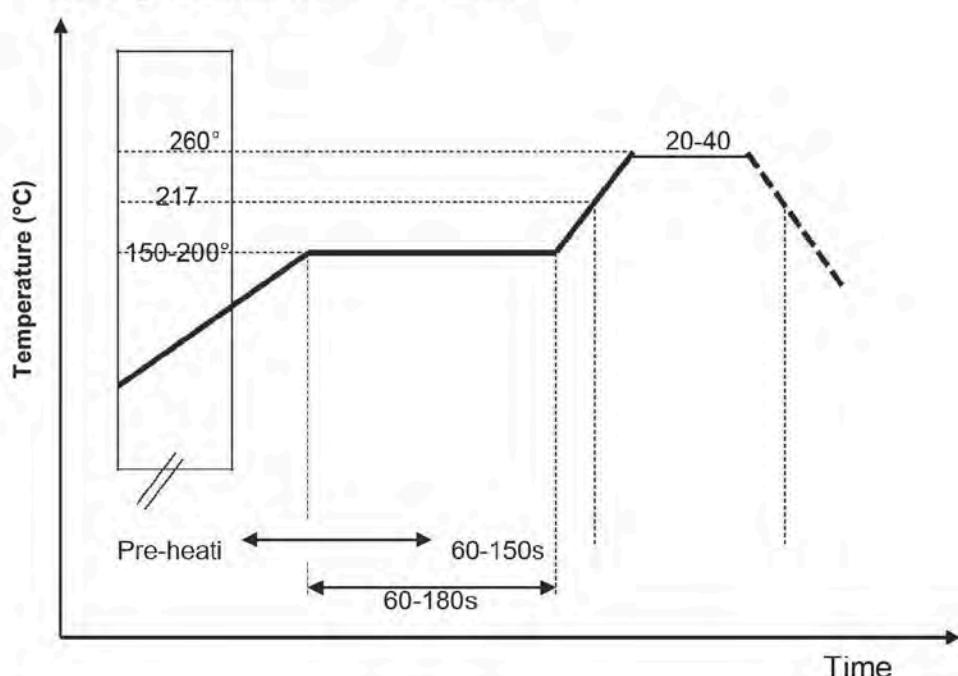
c. Fine tuning element vs. Center frequency



## 10. Soldering Conditions

a.

Typical Soldering Profile for Lead-free Process



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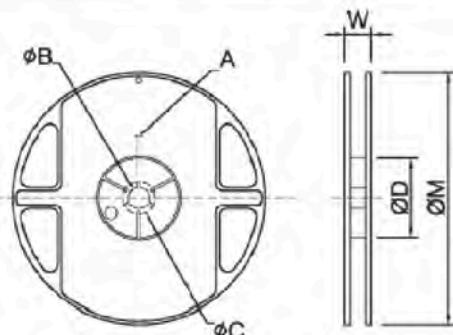
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## 11. Packing

(1) Quantity/Reel: 5000 pcs/Reel:

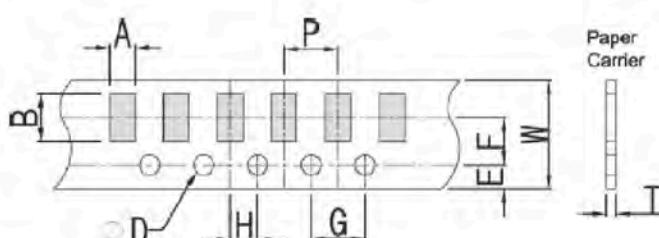
### Reel and Taping Specification

#### Reel Specification



| TYPE | SIZE | A       | φ B     | φ C      | φ D    | W      | φ M      |         |
|------|------|---------|---------|----------|--------|--------|----------|---------|
| 3216 | 7"   | 5K/Reel | 2.0±0.5 | 13.5±1.0 | 21±1.0 | 60±1.0 | 11.5±2.0 | 178±2.0 |

#### Taping Specification



| Packaging  | Type | A         | B         | W        | E         | F        | G        | H        | T         | φ D                 | P       |
|------------|------|-----------|-----------|----------|-----------|----------|----------|----------|-----------|---------------------|---------|
| Paper Type | 3216 | 1.90±0.20 | 3.50±0.20 | 8.0±0.20 | 1.75±0.10 | 3.5±0.05 | 4.0±0.10 | 2.0±0.05 | 0.75±0.10 | 1.50<br>+0.10<br>-0 | 4.0±0.1 |



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## Reliability Table

| Test Item                             | Procedure   | Requirements<br>Ceramic Type  | Remark<br>(Reference)     |
|---------------------------------------|---|---|---------------------------|
| Electrical<br>Characterization        |   | Fulfill the electrical<br>specification                                     | User Spec.                |
| Thermal<br>Shock                      | 1. Preconditioning:<br>50 ± 10°C / 1 hr , then keep for 24 ± 1 hrs at room temp.<br>2. Initial measure: Spec: refer Initial spec.<br>3. Rapid change of temperature test<br>-30°C to +85°C; 100 cycles;<br>15 minutes at Lower category temperature;<br>15 minutes at Upper category temperature. | No Visible Damage.<br>Fulfill the electrical<br>specification.              | MIL-STD-202<br>107        |
| Temperature<br>Cycling                | 1. Initial measure: Spec: refer Initial spec.<br>2. 100 Cycles (-30°C to +85°C), Soak Mode=1 (2 Cycle/hours).<br>3. Measurement at 24 ± 2 Hours after test condition.   | No Visible Damage.<br>Fulfill the electrical<br>specification.              | JESD22<br>JA104           |
| High Temperature<br>Exposure          | 1. Initial measure: Spec: refer Initial spec.<br>2. Unpowered: 500hours @ T=+85°C.<br>3. Measurement at 24 ± 2 hours after test.  | No Visible Damage.<br>Fulfill the electrical<br>specification.              | MIL-STD-202<br>108        |
| Low Temperature<br>Storage            | 1. Initial measure: Spec: refer Initial spec.<br>2. Unpowered: 500hours @ T= -30°C.<br>3. Measurement at 24 ± 2 hours after test.   | No Visible Damage.<br>Fulfill the electrical<br>specification.              | MIL-STD-202<br>108        |
| Solderability<br>(SMD Bottom Side)    | Dipping method:<br>a. Temperature: 235 ± 5°C<br>b. Dipping time: 3 ± 0.5s   | The solder should cover<br>over 95% of the critical<br>area of bottom side. | IEC 60384-21/22<br>4.10   |
| Soldering Heat<br>Resistance<br>(RSH) | Preheating temperature: 150 ± 10°C.<br>Preheating time: 1~2 min.<br>Solder temperature: 260 ± 5°C.<br>Dipping time: 5 ± 0.5s  | No Visible Damage.  | IEC 60384-21/22<br>4.10   |
| Vibration                             | 5g's for 20 min., 12 cycles each of 3 orientations<br>Note: Use 8"X5" PCB .031" thick 7 secure points on, one long<br>side and 2 secure points at corners of opposite sides. Parts<br>mounted within 2' from any secure point. Test from 10-2000<br>Hz.   | No Visible Damage.  | MIL-STD 202<br>Method 204 |
| Mechanical<br>Shock                   | Three shocks in each direction shall be applied along the three<br>mutually perpendicular axes of the test specimen (18 shocks)<br>Peak value: 1,500g's<br>Duration: 0.5ms<br>Velocity change: 15.4 ft/s<br>Waveform: Half-sine   | No Visible Damage.  | MIL-STD-202<br>Method 213 |
| Humidity<br>Bias                      | 1. Humidity: 85% R.H., Temperature: 85 ± 2 °C.<br>2. Time: 500 ± 24 hours.<br>3. Measurement at 24 ± 2 hrs after test condition.  | No Visible Damage.<br>Fulfill the electrical<br>specification.              | MIL-STD-202<br>Method 106 |



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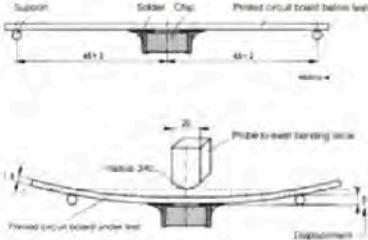
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|                    |   |  |              |
|--------------------|---|--|--------------|
| Board Flex (SMD)   | <p>1. Mounting method:<br/>IR-Reflow. PCB Size (L:100 x W:40 x T:1.6mm)<br/>2. Apply the load in direction of the arrow until bending reaches 2 mm.</p>  | No Visible Damage.   | AEC-Q200 005 |
| Adhesion           | Force of 1.8Kg for 60 seconds.  | No Visible Damage<br>Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body/terminal junction. | AEC-Q200 006 |
| Physical Dimension | Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.  | In accordance with specification   | JESD22 JB100 |



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